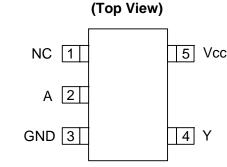


SINGLE BUFFER/DRIVER WITH OPEN DRAIN OUTPUT

Description

The 74LVC1G07 is a single buffer gate with an open drain output. The device is designed for operation with a power supply range of 1.65V to 5.5V. The input is tolerant to 5.5V allowing this device to be used in a mixed voltage environment. The device is fully specified for partial power down applications using I_{OFF} . The I_{OFF} circuitry disables the output preventing damaging current backflow when the device is powered down. The open-drain output can be connected to other open drain outputs to implement activelow wired-OR or active-high wired-AND functions. The maximum sink current is 32 mA.



SOT25 / SOT353

Features

- Wide Supply Voltage Range from 1.65 to 5.5V
- 24mA Output Drive at 3.3V
- CMOS low power consumption
- I_{OFF} Supports Partial-Power-Down Mode Operation
- Inputs accept up to 5.5V
- ESD Protection Exceeds JESD 22
- 200-V Machine Model (A115-A)
- 2000-V Human Body Model (A114-A)
- Latch-Up Exceeds 100mA per JESD 78, Class II
- Range of Package Options
- Direct Interface with TTL Levels
- SOT25 and SOT353: Assembled with "Green" Molding Compound (no Br, Sb)
- Lead Free Finish/ RoHS Compliant (Note 1)

Applications

• Voltage Level Shifting

Pin Assignments

- General Purpose Logic
- Power Down Signal Isolation
- Wide array of products such as.
 - PCs, networking, notebooks, netbooks, PDAs
 - Computer peripherals, hard drives, CD/DVD ROM
 - TV, DVD, DVR, set top box
 - Cell Phones, Personal Navigation / GPS
 - MP3 players ,Cameras, Video Recorders

Notes: 1. EU Directive 2002/95/EC (RoHS). All applicable RoHS exemptions applied. Please visit our website at http://www.diodes.com/products/lead_free.html.

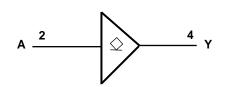


SINGLE BUFFER/DRIVER WITH OPEN DRAIN OUTPUT

Pin Descriptions

Pin Name	Pin NO.	Description
NC	1	No connection
A	2	Data Input
GND	3	Ground
Y	4	Data Output Open Drain
Vcc	5	Supply Voltage

Logic Diagram



Function Table

Inputs	Output
Α	Y
Н	Z
L	L





DECEDES

Absolute Maximum Ratings (Note 2)

Symbol	Description	Rating	Unit
ESD HBM	Human Body Model ESD Protection	2	KV
ESD MM	Machine Model ESD Protection	200	V
V _{CC}	Supply Voltage Range	-0.5 to 6.5	V
VI	Input Voltage Range	-0.5 to 6.5	V
Vo	Voltage applied to output in high impedance or IOFF state	-0.5 to 6.5	V
Vo	Voltage applied to output in high or low state	-0.3 to V _{CC} +0.5	V
I _{IK}	Input Clamp Current V _I <0	-50	mA
Ι _{ΟΚ}	Output Clamp Current	-50	mA
Ι _Ο	Continuous output current	±50	mA
	Continuous current through Vdd or GND	±100	mA
TJ	Operating Junction Temperature	-40 to 150	°C
T _{STG}	Storage Temperature	-65 to 150	°C

Notes: 2. Stresses beyond the absolute maximum may result in immediate failure or reduced reliability. These are stress values and device operation should be within recommend values.





Recommended Operating Conditions (Note 3)

Symbol		Parameter	Min	Max	Unit	
N/		Operating	1.65	5.5	V	
V _{CC}	Operating Voltage	Data retention only	1.5		V	
		V _{CC} = 1.65 V to 1.95 V	0.65 X V _{CC}		V	
V	High-level Input Voltage	$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	1.7			
V _{IH}	nigh-ievel input voltage	$V_{CC} = 3 V \text{ to } 3.6 V$	2		v	
		$V_{CC} = 4.5 V \text{ to } 5.5 V$	$0.7~{\rm X}~{\rm V}_{\rm CC}$			
		V_{CC} = 1.65 V to 1.95 V		$0.35~X~V_{CC}$		
VIL	Low-level input voltage	V_{CC} = 2.3 V to 2.7 V		0.7	V	
VIL	Low-level input voltage	$V_{CC} = 3 V \text{ to } 3.6 V$		0.8		
		V_{CC} = 4.5 V to 5.5 V		$0.3 \text{ V}_{\text{CC}}$		
VI	Input Voltage	0	5.5	V		
Vo	Output Voltage		0	V _{cc}	V	
		V _{CC} = 1.65 V		4		
		$V_{CC} = 2.3 V$		8	mA	
I _{OL}	Low-level output current	$V_{CC} = 3 V$		16		
		$v_{\rm CC} = 3 v$		24		
		$V_{CC} = 4.5 V$		32		
		V_{CC} = 1.8 V ± 0.15V, 2.5 V ± 0.2 V		20	ns/V	
Δt/ΔV	Input transition rise or fall rate	$V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$		10		
		$V_{CC} = 5 V \pm 0.5 V$		5		
T _A	Operating free-air temperature		-40	85	٥C	

Notes: 3. Unused inputs should be held at Vcc or Ground.



SINGLE BUFFER/DRIVER WITH OPEN DRAIN OUTPUT

Electrical Characteristics (All typical values are at Vcc = 3.3V, T_A = 25°C)

Symbol	Parameter	Test Conditions	Vcc	Min	Тур	Max	Unit	
		I _{OL} = 100 μA	1.65 V to 5.5 V			0.1		
		I _{OL} = 4 mA	1.65 V			0.45		
V _{OL}	Low Level	I _{OL} = 8 mA	2.3 V			0.3	V	
V OL	Output Voltage	I _{OL} = 16 mA	-3 V			0.4	v	
		I _{OL} = 24 mA	3 V			0.55		
		I _{OL} = 32 mA	4.5 V			0.55		
I _I	Input Current	$V_1 = 5.5 V \text{ or GND}$	0 to 5.5 V			± 1	μA	
I _{oz}	Z State Leakage Current	V ₀ = 5.5V	3.6 V			± 10	μA	
I _{OFF}	Power Down Leakage Current	V_1 or $V_0 = 5.5V$	0 V			± 10	μA	
I _{CC}	Supply Current	$V_1 = 5.5 \text{ V or GND } I_0 = 0$	1.65 V to 5.5 V			10	μA	
ΔI _{CC}	Additional Supply Current	Input at V _{CC} –0.6 V	3 V to 5.5 V			500	μA	
Ci	Input Capacitance	$V_I = V_{CC}$ or GND	3.3V		4		pF	
Co	Output Capacitance	V _O = V _{CC} or GND	3.3V		5		pF	
0	Thermal Resistance	SOT25	(Note 4)		204			
θ_{JA}	Junction-to-Ambient	SOT353	(Note 4)		371		°C/W	
٥	Thermal Resistance	SOT25	(Note 4)		52			
$\theta^{\rm JC}$	Junction-to-Case	SOT353	(Note 4)		143			

Over recommended free-air temperature range (unless otherwise noted)

Notes: 4. Test condition for SOT25 and SOT353: Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.



SINGLE BUFFER/DRIVER WITH OPEN DRAIN OUTPUT

Switching Characteristics

Over recommended free-air temperature range, CL = 30 or 50pF (unless otherwise noted) (see Figure 1)

Parameter	From	TO	Vcc = ± 0.		Vcc = ± 0	2.5 V .2V	Vcc = ± 0			= 5 V 0.5V	Unit
(Input) (Ol	(OUTPUT)	Min	Max	Min	Max	Min	Max	Min	Max		
t _{pd}	А	Y	1.5	8.3	1.0	5.5	1.5	4.2	1.0	3.5	ns

Operating Characteristics

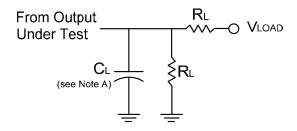
T_A = 25 °C

Parameter		Test	Vcc = 1.8 V	Vcc = 2.5 V	Vcc = 3.3 V	Vcc = 5 V	Unit
		Conditions	TYP	TYP	ТҮР	ТҮР	•
C_{pd}	Power dissipation capacitance	f = 10 MHz	3	3	4	6	pF



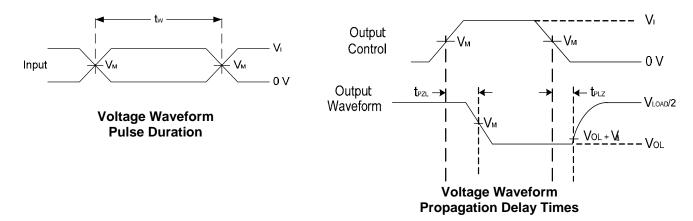
SINGLE BUFFER/DRIVER WITH **OPEN DRAIN OUTPUT**

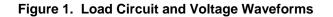
Parameter Measurement Information

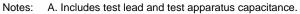


TEST	Condition
t _{PLZ} (see Notes D and E)	Vload
t _{PZL} (see Notes D and F)	Vload

Vcc	Inp	uts	V _M	V _{LOAD}	CL	RL	VA
	VI	t _r /t _f	- 101	LOAD			
1.8V±0.15V	V _{cc}	≤2ns	V _{CC} /2	2 X V _{cc}	30pF	1KΩ	0.15V
2.5V±0.2V	V _{cc}	≤2ns	V _{CC} /2	2 X V _{cc}	30pF	500Ω	0.15V
3.3V±0.3V	3V	≤2.5ns	1.5V	6V	50pF	500Ω	0.3V
5V±0.5V	V _{cc}	≤2.5ns	V _{cc} /2	2 X V _{CC}	50pF	500Ω	0.3V





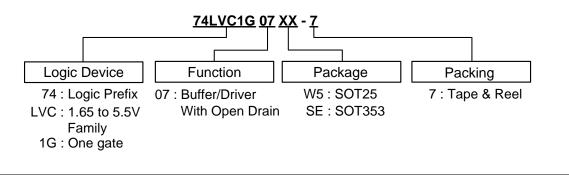


- B. All pulses are supplied at pulse repetition rate ≤ 10 MHz
- C. The inputs are measured one at a time with one transition per measurement.
- D. For the open drain device t_{PLZ} and t_{PZL} are the same as t_{PD}
- E. t_{PZL} is measured at V_M. F. t_{PLZ} is measured at V_{OL} +V_A



SINGLE BUFFER/DRIVER WITH OPEN DRAIN OUTPUT

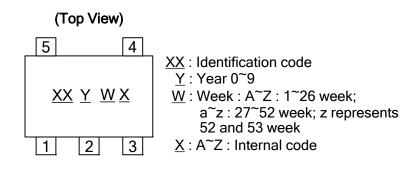
Ordering Information



	Device	Package	Packaging	7" Tape and Reel	
	Device	Code	(Note 5)	Quantity	Part Number Suffix
Pb,	74LVC1G07W5-7	W5	SOT25	3000/Tape & Reel	-7
•	74LVC1G07SE-7	SE	SOT353	3000/Tape & Reel	-7

Notes: 5. Pad layout as shown on Diodes Inc. suggested pad layout document AP02001, which can be found on our website at http://www.diodes.com/datasheets/ap02001.pdf.

Marking Information



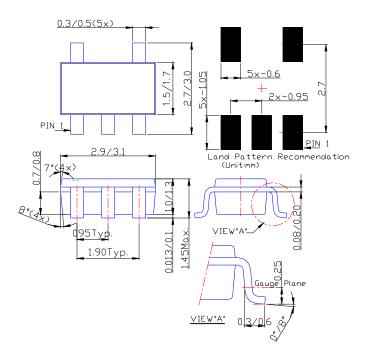
Part Number	Package	Identification Code	
74LVC1G07W5	SOT25	UN	
74LVC1G07SE	SOT353	UN	



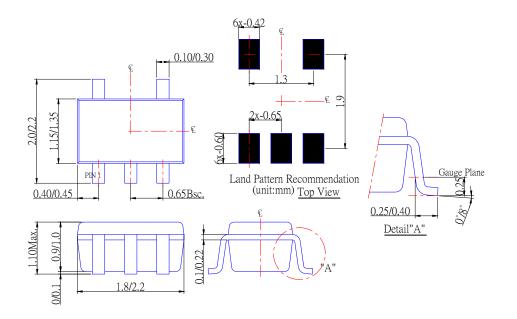
SINGLE BUFFER/DRIVER WITH OPEN DRAIN OUTPUT

Package Outline Dimensions (All Dimensions in mm)

(1) Package Type: SOT25



(2) Package Type: SOT353



74LVC1G07 Document number: DS32274 Rev. 1 - 2



SINGLE BUFFER/DRIVER WITH OPEN DRAIN OUTPUT



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